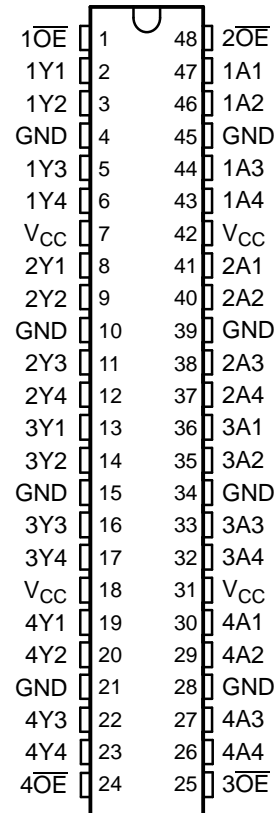


## FEATURES

- Qualification in Accordance With AEC-Q100 <sup>(1)</sup>
- Qualified for Automotive Applications
- Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
- Controlled Baseline
  - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree
- Member of the Texas Instruments Widebus™ Family
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max  $t_{pd}$  of 4.1 ns at 3.3 V
- Typical  $V_{OLP}$  (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot) >2 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation On All Ports (5-V Input/Output Voltage With 3.3-V  $V_{CC}$ )
- Latch-Up Performance Exceeds 100 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

(1) Contact factory for details. Q100 qualification data available on request.

**DGG PACKAGE  
(TOP VIEW)**



## DESCRIPTION/ORDERING INFORMATION

This 16-bit buffer/driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74LVC16244A is designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

### ORDERING INFORMATION

| $T_A$         | PACKAGE <sup>(1)</sup> |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|------------------------|---------------|-----------------------|------------------|
| –40°C to 85°C | TSSOP – DGG            | Tape and reel | CLVC16244AIDGGRQ1     | C16244AQ1        |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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## DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. It provides true outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

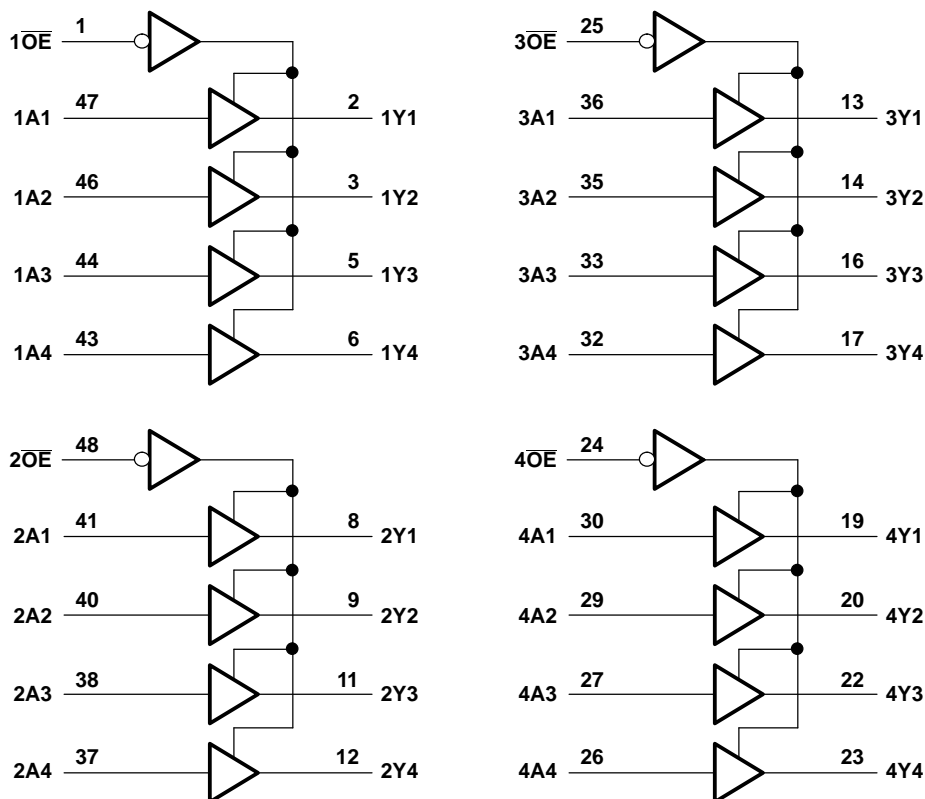
This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

**FUNCTION TABLE**

| INPUTS          |   | OUTPUT<br>Y |
|-----------------|---|-------------|
| $\overline{OE}$ | A |             |
| L               | H | H           |
| L               | L | L           |
| H               | X | Z           |

**LOGIC DIAGRAM (POSITIVE LOGIC)**



## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|               |   | MIN       | MAX            | UNIT |
|---------------|---|-----------|----------------|------|
| $V_{CC}$      | Supply voltage  | –0.5      | 6.5            | V    |
| $V_I$         | Input voltage range <sup>(2)</sup>  | –0.5      | 6.5            | V    |
| $V_O$         | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | –0.5      | 6.5            | V    |
| $V_O$         | Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>              | –0.5      | $V_{CC} + 0.5$ | V    |
| $I_{IK}$      | Input clamp current   | $V_I < 0$ | –50            | mA   |
| $I_{OK}$      | Output clamp current  | $V_O < 0$ | –50            | mA   |
| $I_O$         | Continuous output current   |           | ±50            | mA   |
|               | Continuous current through each $V_{CC}$ or GND   |           | ±100           | mA   |
| $\theta_{JA}$ | Package thermal impedance <sup>(4)</sup>  |           | 70             | °C/W |
| $T_{stg}$     | Storage temperature range   | –65       | 150            | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of  $V_{CC}$  is provided in the recommended operating conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

## Recommended Operating Conditions<sup>(1)</sup>

|                     |                                    | MIN  | MAX                  | UNIT     |
|---------------------|------------------------------------|--|----------------------|----------|
| $V_{CC}$            | Supply voltage                     | Operating                                    | 1.65                 | 3.6      |
|                     |                                    | Data retention only                          | 1.5                  |          |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | $0.65 \times V_{CC}$ |          |
|                     |                                    | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | 1.7                  |          |
|                     |                                    | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | 2                    |          |
| $V_{IL}$            | Low-level input voltage            | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | $0.35 \times V_{CC}$ |          |
|                     |                                    | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | 0.7                  |          |
|                     |                                    | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | 0.8                  |          |
| $V_I$               | Input voltage                      | 0  | 5.5                  | V        |
| $V_O$               | Output voltage                     | High or low state                            | 0                    | $V_{CC}$ |
|                     |                                    | 3-state                                      | 0                    | 5.5      |
| $I_{OH}$            | High-level output current          | $V_{CC} = 1.65 \text{ V}$                    | –4                   |          |
|                     |                                    | $V_{CC} = 2.3 \text{ V}$                     | –8                   |          |
|                     |                                    | $V_{CC} = 2.7 \text{ V}$                     | –12                  |          |
|                     |                                    | $V_{CC} = 3 \text{ V}$                       | –24                  |          |
| $I_{OL}$            | Low-level output current           | $V_{CC} = 1.65 \text{ V}$                    | 4                    |          |
|                     |                                    | $V_{CC} = 2.3 \text{ V}$                     | 8                    |          |
|                     |                                    | $V_{CC} = 2.7 \text{ V}$                     | 12                   |          |
|                     |                                    | $V_{CC} = 3 \text{ V}$                       | 24                   |          |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |  | 10                   | ns/V     |
| $T_A$               | Operating free-air temperature     | –40  | 85                   | °C       |

- (1) All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN74LVC16244A-Q1

## 16-BIT BUFFER/DRIVER

### WITH 3-STATE OUTPUTS

SCES631–MAY 2005

## Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)



| PARAMETER        | TEST CONDITIONS  | V <sub>CC</sub> | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |
|------------------|--|-----------------|-----------------------|--------------------|------|------|
| V <sub>OH</sub>  | I <sub>OH</sub> = –100 µA  | 1.65 V to 3.6 V | V <sub>CC</sub> – 0.2 |                    |      | V    |
|                  | I <sub>OH</sub> = –4 mA  | 1.65 V          | 1.2                   |                    |      |      |
|                  | I <sub>OH</sub> = –8 mA  | 2.3 V           | 1.7                   |                    |      |      |
|                  | I <sub>OH</sub> = –12 mA   | 2.7 V           | 2.2                   |                    |      |      |
|                  |  | 3 V             | 2.4                   |                    |      |      |
|                  | I <sub>OH</sub> = –24 mA   | 3 V             | 2.2                   |                    |      |      |
| V <sub>OL</sub>  | I <sub>OL</sub> = 100 µA   | 1.65 V to 3.6 V |                       |                    | 0.2  | V    |
|                  | I <sub>OL</sub> = 4 mA   | 1.65 V          |                       |                    | 0.45 |      |
|                  | I <sub>OL</sub> = 8 mA   | 2.3 V           |                       |                    | 0.7  |      |
|                  | I <sub>OL</sub> = 12 mA  | 2.7 V           |                       |                    | 0.4  |      |
|                  | I <sub>OL</sub> = 24 mA  | 3 V             |                       |                    | 0.55 |      |
| I <sub>I</sub>   | V <sub>I</sub> = 0 to 5.5 V  | 3.6 V           |                       |                    | ±5   | µA   |
| I <sub>Off</sub> | V <sub>I</sub> or V <sub>O</sub> = 5.5 V                                     | 0               |                       |                    | ±10  | µA   |
| I <sub>OZ</sub>  | V <sub>O</sub> = 0 to 5.5 V  | 3.6 V           |                       |                    | ±10  | µA   |
| I <sub>CC</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.6 V           |                       |                    | 20   | µA   |
|                  | 3.6 V ≤ V <sub>I</sub> ≤ 5.5 V <sup>(2)</sup>                                |                 |                       |                    | 20   |      |
| ΔI <sub>CC</sub> | One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND | 2.7 V to 3.6 V  |                       |                    | 500  | µA   |
| C <sub>i</sub>   | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           |                       |                    | 5.5  | pF   |
| C <sub>o</sub>   | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           |                       |                    | 6    | pF   |

(1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

(2) This applies in the disabled state only.

## Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 1](#))

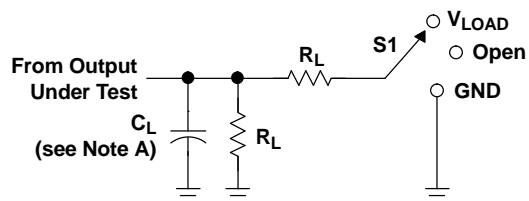
| PARAMETER          | FROM<br>(INPUT)   | TO<br>(OUTPUT) | V <sub>CC</sub> = 1.8 V |      | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|--------------------|---|----------------|-------------------------|------|------------------------------------|-----|-------------------------|-----|------------------------------------|-----|------|
|                    |   |                | MIN                     | MAX  | MIN                                | MAX | MIN                     | MAX | MIN                                | MAX |      |
| t <sub>pd</sub>    | A   | Y              | 0.5                     | 6.6  | 0.5                                | 5.9 | 0.5                     | 4.7 | 0.5                                | 4.1 | ns   |
| t <sub>en</sub>    |  | Y              | 0.5                     | 7.5  | 0.5                                | 6.7 | 0.5                     | 5.8 | 0.5                                | 4.6 | ns   |
| t <sub>dis</sub>   |  | Y              | 0.5                     | 10.3 | 0.5                                | 8.3 | 0.5                     | 6.2 | 0.5                                | 5.8 | ns   |
| t <sub>sk(o)</sub> |   |                |                         |      |                                    |     |                         |     |                                    | 1   | ns   |

## Operating Characteristics

T<sub>A</sub> = 25°C

| PARAMETER       |  |                  | TEST<br>CONDITIONS | V <sub>CC</sub> = 1.8 V | V <sub>CC</sub> = 2.5 V | V <sub>CC</sub> = 3.3 V | UNIT |
|-----------------|--|------------------|--------------------|-------------------------|-------------------------|-------------------------|------|
|                 |  |                  |                    | TYP                     | TYP                     | TYP                     |      |
| C <sub>pd</sub> | Power dissipation capacitance<br>per buffer/driver | Outputs enabled  | f = 10 MHz         | 33                      | 35                      | 39                      | pF   |
|                 |  | Outputs disabled |                    | 2                       | 3                       | 4                       |      |

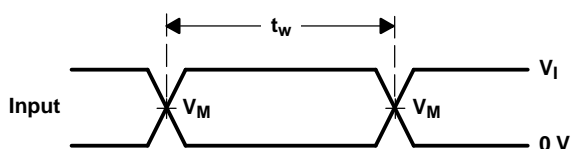
## PARAMETER MEASUREMENT INFORMATION



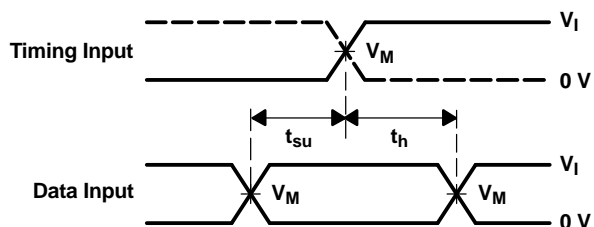
LOAD CIRCUIT

| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

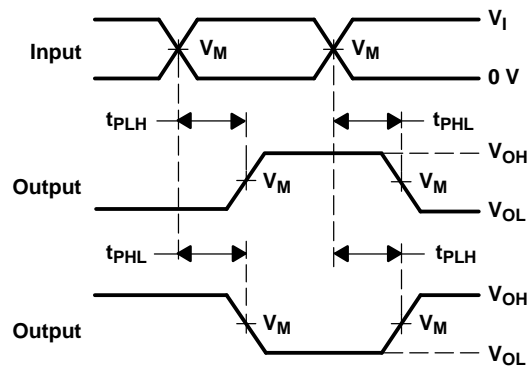
| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 $\Omega$ | 0.15 V       |
| 2.7 V                            | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |



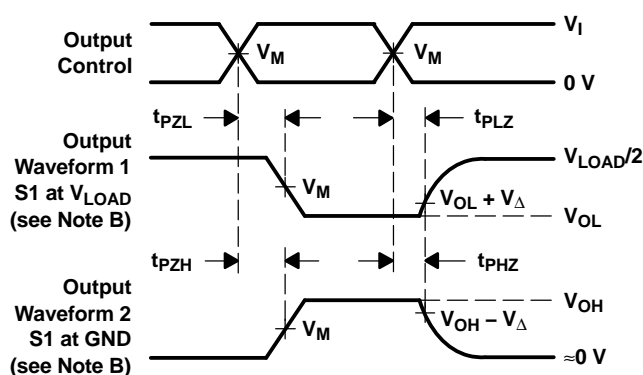
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ .
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CLVC16244AIDGGRQ1</a> | Active        | Production           | TSSOP (DGG)   48 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | C16244AQ1           |
| CLVC16244AIDGGRQ1.B               | Active        | Production           | TSSOP (DGG)   48 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | C16244AQ1           |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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### OTHER QUALIFIED VERSIONS OF SN74LVC16244A-Q1 :

- Catalog : [SN74LVC16244A](#)

- Enhanced Product : [SN74LVC16244A-EP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CLVC16244AIDGGRQ1 | TSSOP        | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |

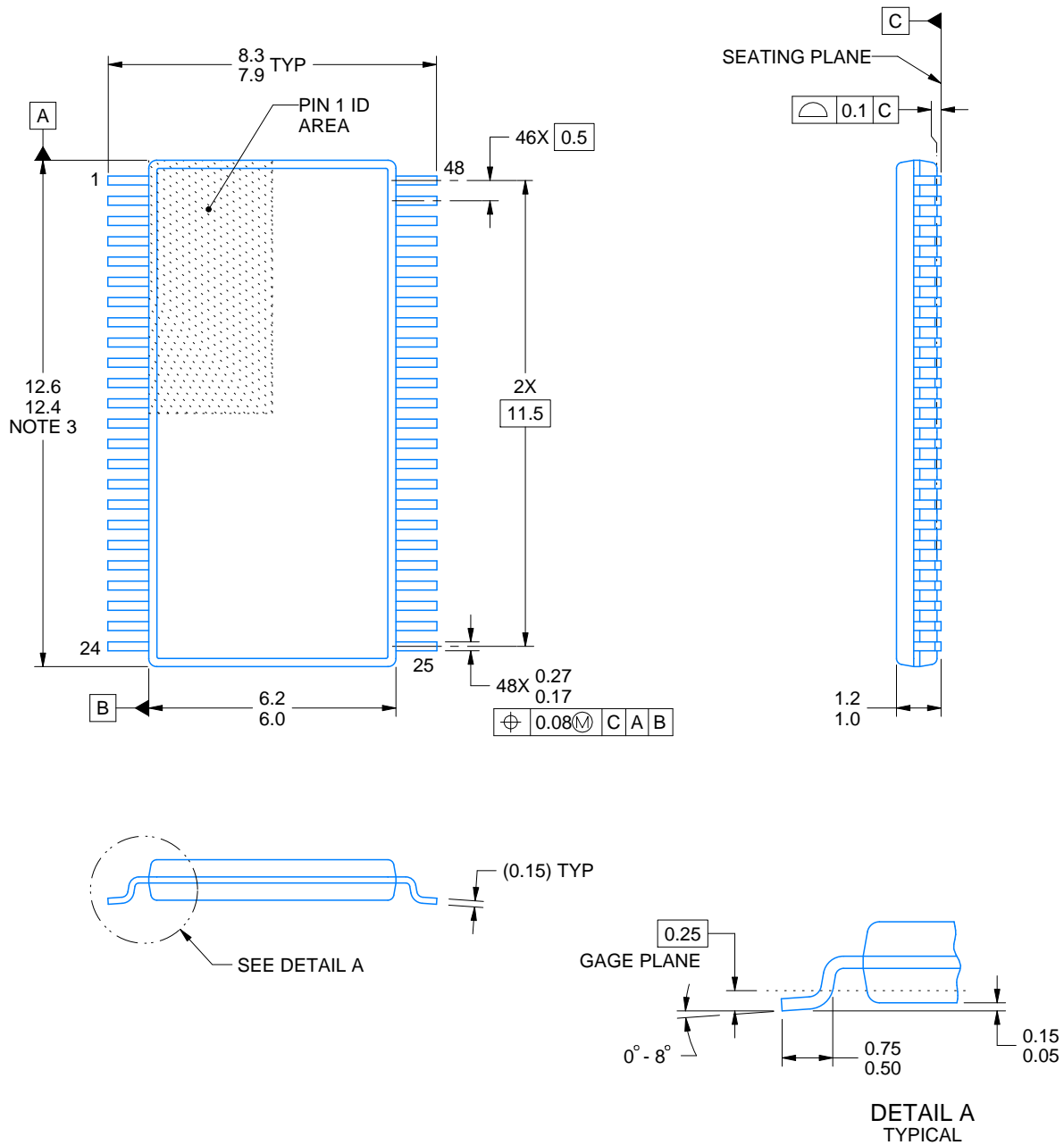
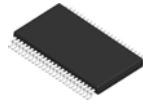


## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CLVC16244AIDGGRQ1 | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |



4214859/B 11/2020

## NOTES:

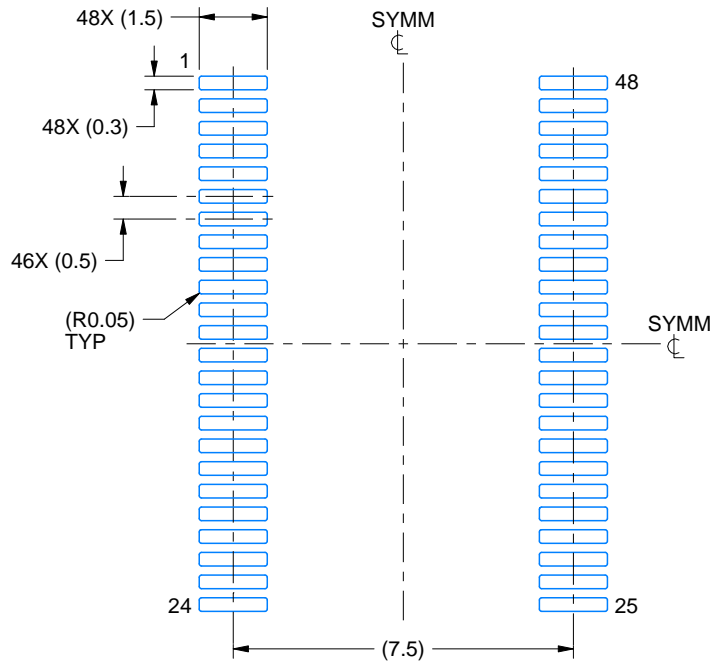
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

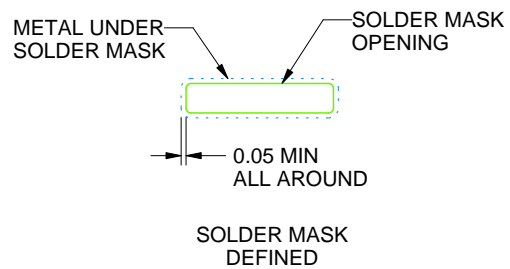
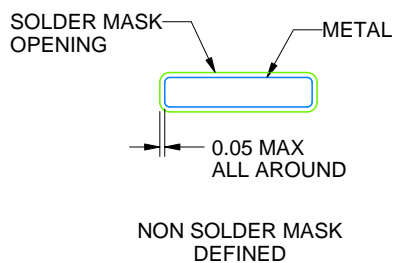
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4214859/B 11/2020

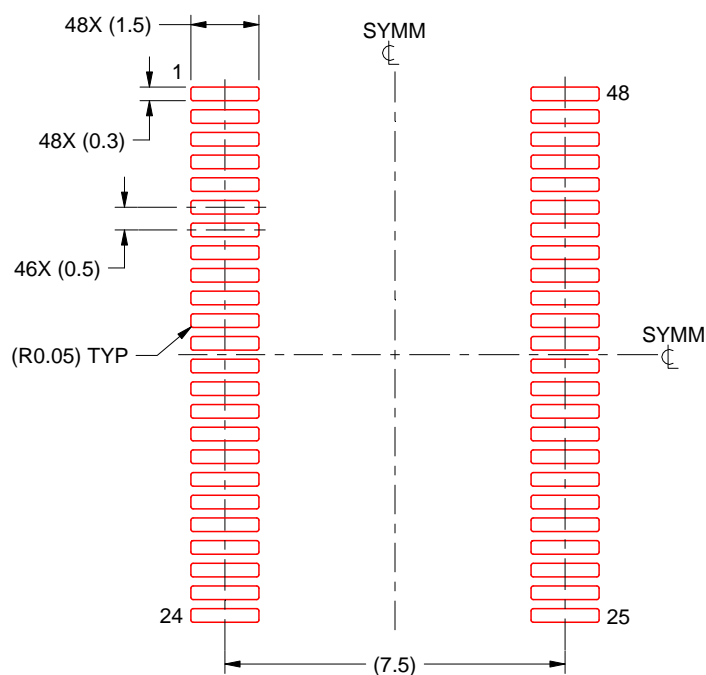
NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

**DGG0048A**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4214859/B 11/2020

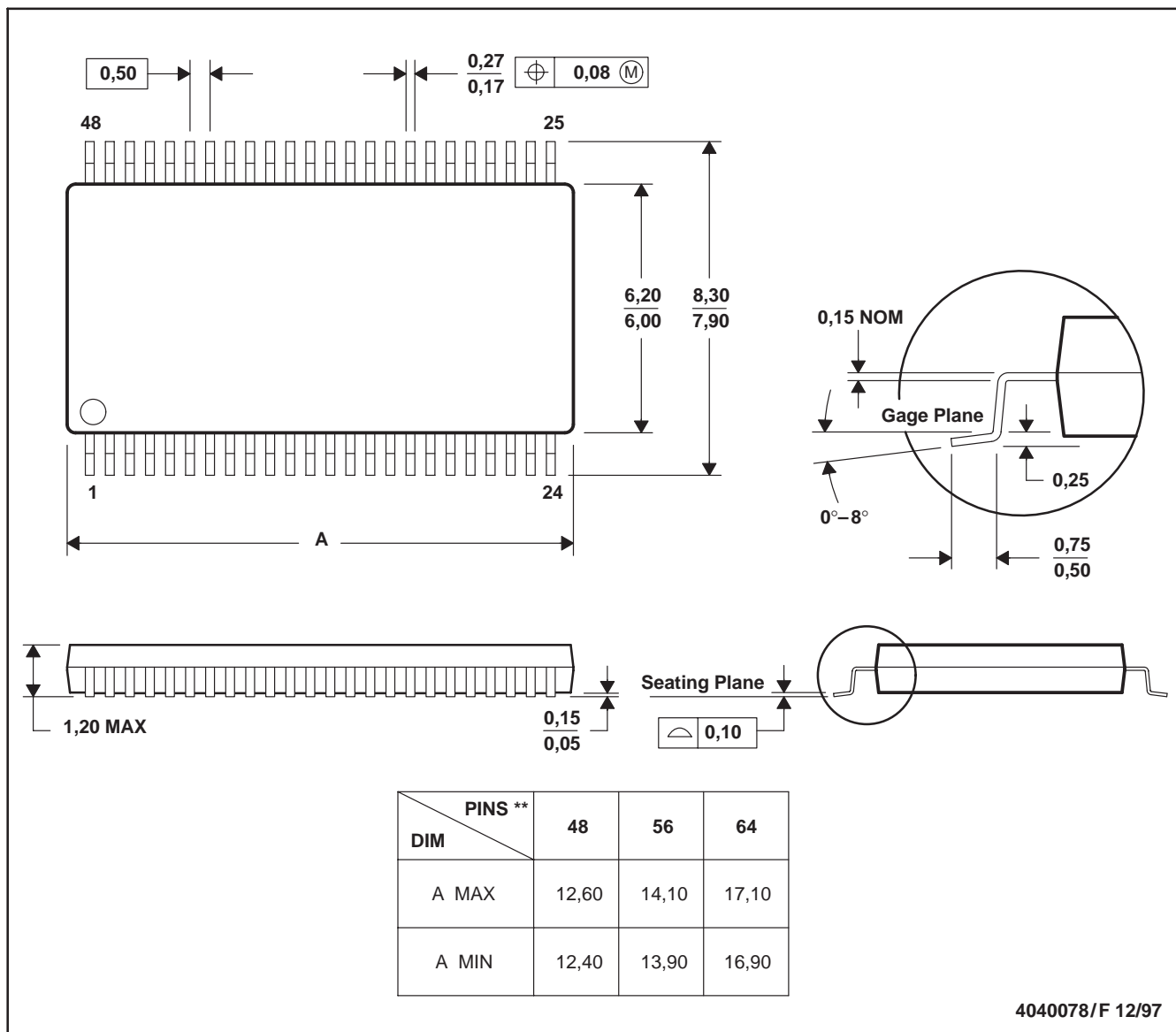
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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